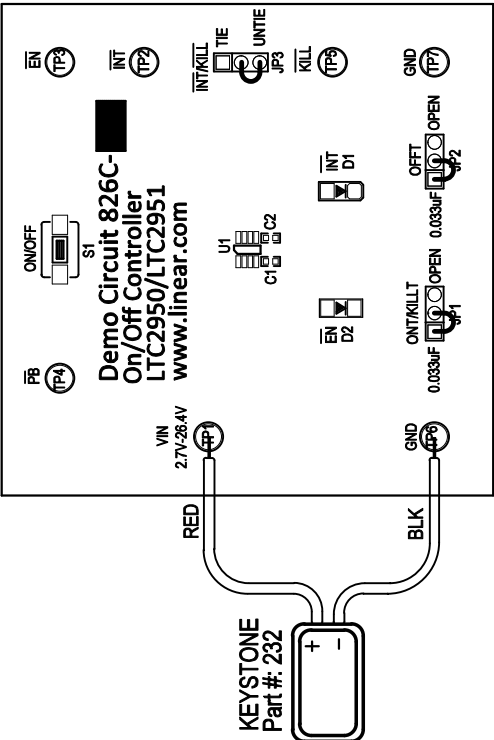
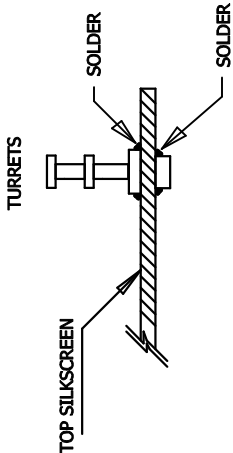


REVISION HISTORY				
ECO	REV	DESCRIPTION	APPR	DATE
—	C	PRODUCTION	Dilian Reyes	Nov 19, 2013


NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 deg C.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNT AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.



BOARD ASSEMBLY

	U1
DC826C-A	LTC2950CTS8-2
DC826C-B	LTC2951CTS8-2

APPROVALS		 1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: 408/432-1900 www.linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY	
PCB DES.	RB		
	Dilian Reyes	TITLE: TOP ASSEMBLY DRAWING On/Off Controller	
		SIZE	IC NO. LTC2950/LTC2951
		N/A	REV. DEMO CIRCUIT 826C 1
SCALE = NONE		FILENAME: 826C-Rev1.PCB	
		SHT 1 OF 2	